


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	AMS/23/14319	
1.3 Title of PCN	Qualification of TFME Tongke for Assembly and Test for selected TO220 package	
1.4 Product Category	See product list	
1.5 Issue date	2023-10-16	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Marcello SAN BIAGIO
2.1.2 Marketing Manager	Salvatore DI VINCENZO
2.1.3 Quality Manager	Jean-Marc BUGNARD

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Product transfer from one site to another site, even if test or process line is qualified	TFME Tongke

4. Description of change

	Old	New
4.1 Description	Assembly and test : - ST Shenzhen	Assembly and test : - ST Shenzhen - TFME Tongke
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	The purpose of the introduction of TFME Tongke for Assembly and Test & Finishing activities is to further improve the rationalization of our manufacturing assets and provide a better support to our customers by enhancing the manufacturing process for higher volume production.
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	New Finished good codes
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7. Timing / schedule

7.1 Date of qualification results	2023-09-29
7.2 Intended start of delivery	2024-01-20
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	14319 RER 6088-1810-W-2023_TO220 FP_SG_DG_TFME TONGKE - CHINA.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2023-10-16

9. Attachments (additional documentations)

14319 Public product.pdf
14319 RER 6088-1810-W-2023_TO220 FP_SG_DG_TFME TONGKE - CHINA.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
497-4226-5-ND	L7805ABP	
L7805ABP	L7805ABP	
497-1442-5-ND	L7805CP	
L7805CP	L7805CP	
497-1451-5-ND	L7812CP	
L7812CP	L7812CP	
L7815CP	L7815CP	
L7824CP	L7824CP	
L7905CP	L7905CP	
L7912CP	L7912CP	
L7915CP	L7915CP	
LM317P	LM317P	



Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title : Qualification of TFME Tongke for Assembly and Test for selected TO220 package

PCN Reference : AMS/23/14319

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

L7812CP	L7905CP	LM317P
L7815CP	L7912CP	L7805ABP
L7805CP	L7915CP	L7824CP

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